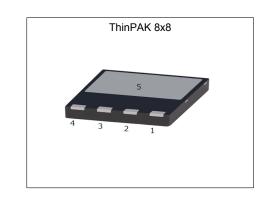


MOSFET

650V CoolMOS™ C7 Power Transistor

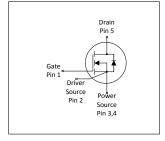
CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies.

CoolMOS™ C7 series combines the experience of the leading SJ MOSFET supplier with high class innovation. The product portfolio provides all benefits of fast switching superjunction MOSFETs offering better efficiency, reduced gate charge, easy implementation and outstanding reliability.



Features

- Increased MOSFET dv/dt ruggedness
- Better efficiency due to best in class FOM R_{DS(on)}*E_{oss} and R_{DS(on)}*Q_g
- ThinPAK SMD Package with very low parasitic inductance to enable fast and reliable switching with minimum of size to increase power-density
- Easy to use/drive due to **driver source pin** for better control of the gate.
- Pb-free plating, halogen free mold compound
- Qualified for industrial grade applications according to JEDEC (J-STD20 and JESD22)



Benefits

- · Enabling higher system efficiency by lower switching losses
- Enabling higher frequency / increased power density solutions
- System cost / size savings due to reduced cooling requirements
- · Higher system reliability due to lower operating temperatures







Potential applications

PFC stages and hard switching PWM stages for e.g. Computing, Server, Telecom, UPS and Solar.

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.

Table 1 Key Performance Parameters

Parameter	Value	Unit
V _{DS} @ T _{j,max}	700	V
R _{DS(on),max}	70	m $Ω$
$Q_{g,typ}$	64	nC
$I_{D,pulse}$	145	A
E _{oss} @ 400V	8	μJ
Body diode di _F /dt	60	A/µs

Type / Ordering Code	Package	Marking	Related Links
IPL65R070C7	PG-VSON-4	65C7070	see Appendix A

650V CoolMOS™ C7 Power Transistor IPL65R070C7



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650V CoolMOS™ C7 Power Transistor IPL65R070C7



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Barranatan	Values						
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	28 20	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	145	Α	T _C =25°C	
Avalanche energy, single pulse	E AS	-	-	171	mJ	I_D =10.2A; V_{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	0.85	mJ	I_D =10.2A; V_{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	10.2	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	100	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	169	W	<i>T</i> _C =25°C	
Storage temperature	$T_{ m stg}$	-40	-	150	°C	-	
Operating junction temperature	T _j	-40	-	150	°C	-	
Mounting torque	-	-	-	n.a.	Ncm	-	
Continuous diode forward current	Is	-	-	28	Α	<i>T</i> _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	- 145 A T _C =25°C		T _C =25°C		
Reverse diode dv/dt ³⁾	dv/dt	-	-	1.5	V/ns V_{DS} =0400V, I_{SD} <= I_{S} , T_{j} =25°C see table 8		
Maximum diode commutation speed	di _F /dt	-	-	60	A/μs	V_{DS} =0400V, I_{SD} <= I_{S} , T_{j} =25°C see table 8	
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	$V_{\rm rms}$, $T_{\rm C}$ =25°C, t =1min	

 $^{^{1)}}$ Limited by $T_{j\,max}.$ $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical \textit{R}_{G}

650V CoolMOS™ C7 Power Transistor IPL65R070C7



2 Thermal characteristics

Table 3 Thermal characteristics

Dougnator	Cumbal		Values			Nata / Tank Canadikian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	0.74	°C/W	-	
Thermal resistance, junction - ambient	R _{thJA}	-	-	62	°C/W	device on PCB, minimal footprint	
Thermal resistance, junction - ambient for SMD version	$R_{ m thJA}$	-	35	45	°C/W	Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thickness) copper area for drain connection and cooling. PCB is vertical without air stream cooling.	
Reflow soldering temperature	T _{sold}	-	-	260	°C	reflow MSL2a	

650V CoolMOS™ C7 Power Transistor IPL65R070C7



3 Electrical characteristics at T_j =25°C, unless otherwise specified

Table 4 **Static characteristics**

Danier de la constante de la c	Ola a l	Values			11:4	Nata (Table Operation	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	650	-	-	V	V_{GS} =0V, I_D =1mA	
Gate threshold voltage	$V_{(GS)th}$	3	3.5	4	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 0.85 {\rm mA}$	
Zero gate voltage drain current	I _{DSS}	-	- 15	1 -	μΑ	V _{DS} =650, V _{GS} =0V, T _j =25°C V _{DS} =650, V _{GS} =0V, T _j =150°C	
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V	
Drain-source on-state resistance	R _{DS(on)}	-	0.062 0.149	0.070	Ω	V _{GS} =10V, I _D =8.5A, T _i =25°C V _{GS} =10V, I _D =8.5A, T _i =150°C	
Gate resistance	R _G	-	0.85	-	Ω	f=1MHz, open drain	

Table 5 **Dynamic characteristics**

Parameter	Or made at		Value	s	1114		
Parameter	Symbol	Min.			Unit	Note / Test Condition	
Input capacitance	Ciss	-	3020	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Output capacitance	Coss	-	48	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	100	-	pF	V _{GS} =0V, V _{DS} =0400V	
Effective output capacitance, time related ²⁾			I _D =constant, V _{GS} =0V, V _{DS} =0400V				
		$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =8.5A, $R_{\rm G}$ =5.3 Ω ; see table 9					
RISETIME IT. II IN II INS I		$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =8.5A, $R_{\rm G}$ =5.3 Ω ; see table 9					
		$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =8.5A, $R_{\rm G}$ =5.3 Ω ; see table 9					
Fall time	t _f	-	11	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13 V, $I_{\rm D}$ =8.5A, $R_{\rm G}$ =5.3 Ω ; see table 9	

Table 6 **Gate charge characteristics**

Parameter	C: mah al		Value	s	11	Nata / Taat Canalitian	
	Symbol	Min. Typ. Max.		Unit	Note / Test Condition		
Gate to source charge	Q _{gs}	-	16	-	nC	$V_{\rm DD}$ =400V, $I_{\rm D}$ =8.5A, $V_{\rm GS}$ =0 to 10V	
Gate to drain charge	$Q_{ m gd}$	-	21	-	nC	$V_{\rm DD}$ =400V, $I_{\rm D}$ =8.5A, $V_{\rm GS}$ =0 to 10V	
Gate charge total	Qg	-	64	-	nC	$V_{\rm DD}$ =400V, $I_{\rm D}$ =8.5A, $V_{\rm GS}$ =0 to 10V	
Gate plateau voltage	$V_{ m plateau}$	-	5.0	-	V	$V_{\rm DD}$ =400V, $I_{\rm D}$ =8.5A, $V_{\rm GS}$ =0 to 10V	

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

650V CoolMOS™ C7 Power Transistor

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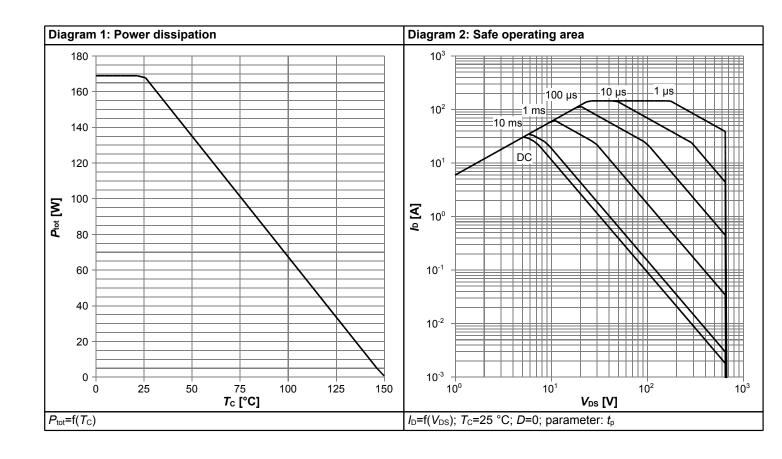


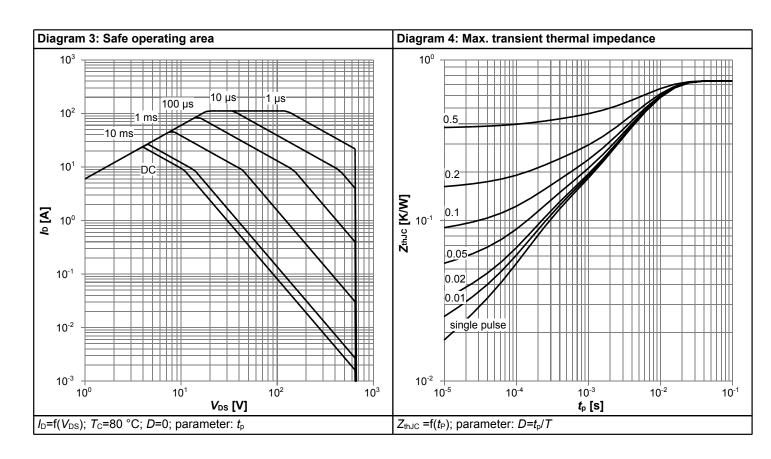
Table 7 Reverse diode characteristics

Doromotor	Cumbal		Values		I Imi4	Note / Test Condition	
Parameter	Symbol	Min. Typ. Max.		Unit	Note / Test Condition		
Diode forward voltage	V _{SD}	-	0.8	-	V	V _{GS} =0V, I _F =8.5A, T _j =25°C	
Reverse recovery time	t _{rr}	-	800	_	ns	V_R =400V, I_F =28A, di_F/dt =60A/ μ s; see table 8	
Reverse recovery charge	Qrr	-	10	-	μC	V_R =400V, I_F =28A, di_F/dt =60A/ μ s; see table 8	
Peak reverse recovery current	I _{rrm}	-	30	-	А	V_R =400V, I_F =28A, di_F/dt =60A/ μ s; see table 8	

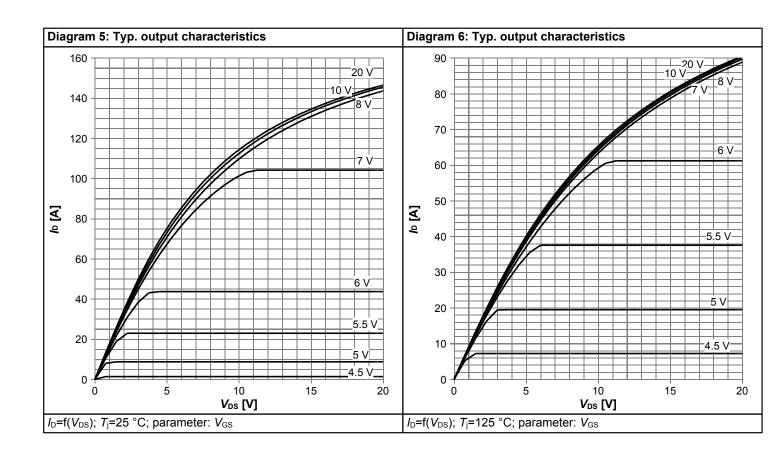


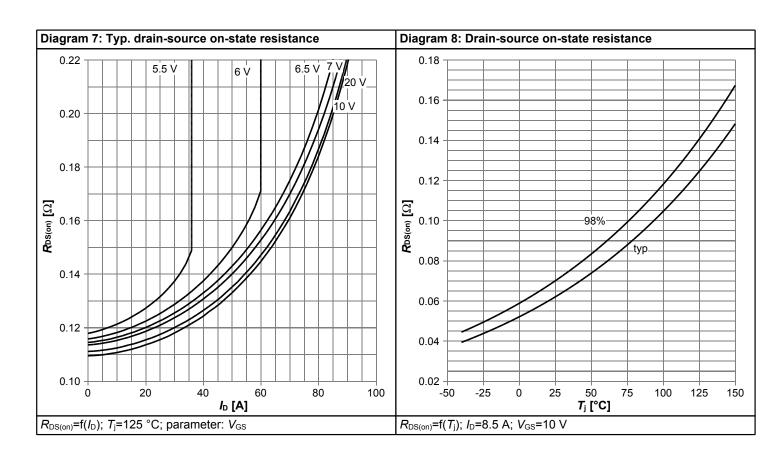
4 Electrical characteristics diagrams



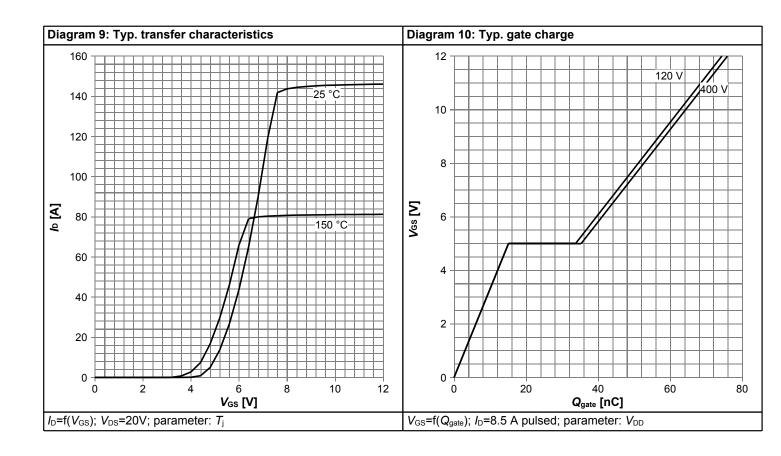


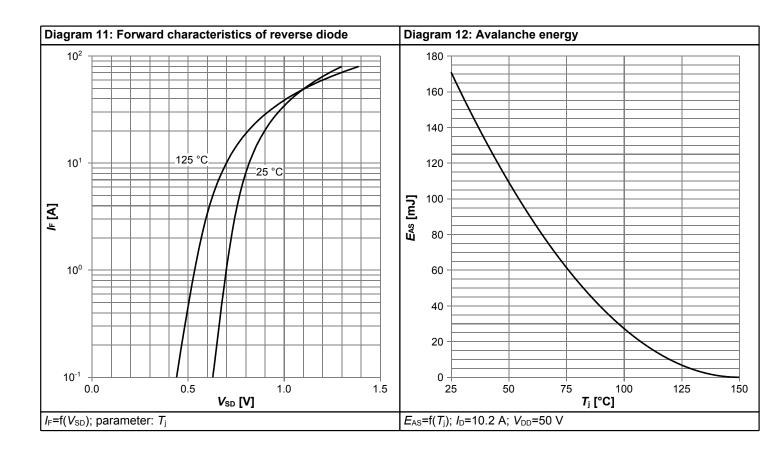




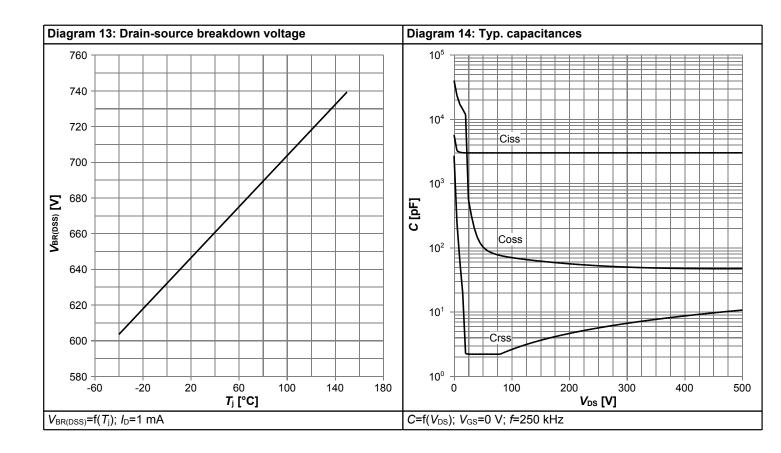


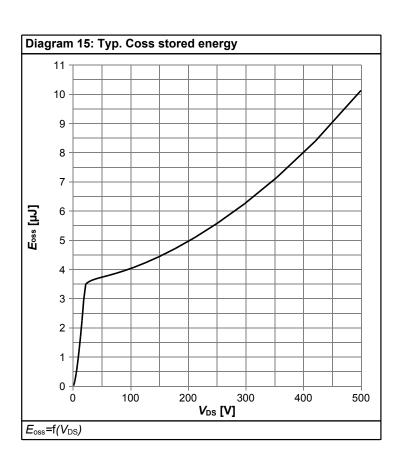














5 Test Circuits

Table 8 Diode characteristics

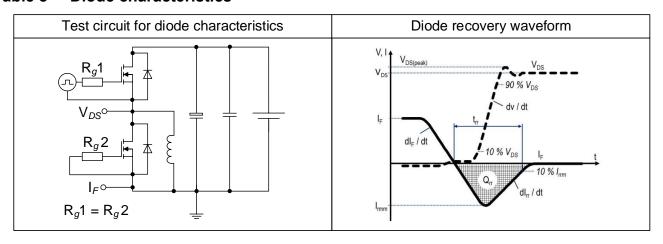


Table 9 switching times (ss)

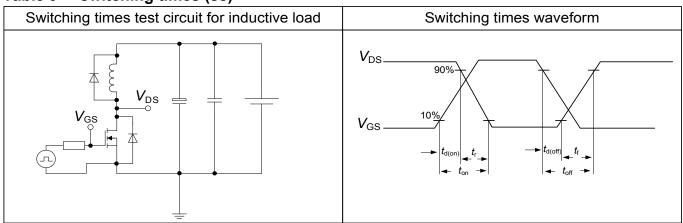
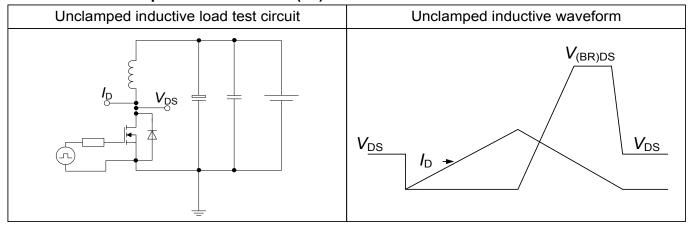
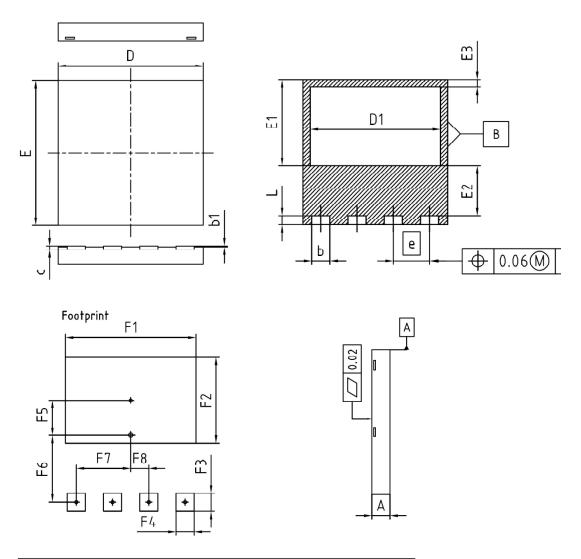


Table 10 Unclamped inductive load (ss)





6 Package Outlines



DIM	MILLIME	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	0.90	1.10	0.035	0.043	
b	0.90	1.10	0.035	0.043	
ь1	0.00	0.05	0.000	0.002	
С	0.10	0.30	0.004	0.012	
D	7.90	8.10	0.311	0.319	
D1	7.10	7.30	0.280	0.287	
E	7.90	8.10	0.311	0.319	
E1	4.65	4.85	0.183	0.191	
E2	2.65	2.85	0.104	0.112	
E3	0.30	0.50	0.012	0.020	
е	2.	00 (BSC)	0.079 (BSC)		
L	0.40	0.60	0.016	0.024	
N	4	4		4	
F1	7.2	20	0.283		
F2	4.7	' 5	0.187		
F3	1.0	0	0.039		
F4	1.0	0	0.039		
F5	1.4	3	0.056		
F6	4.2	20	0.165		
F7	3.0	00	0.118		
F8	1.0	0	0.0)39	

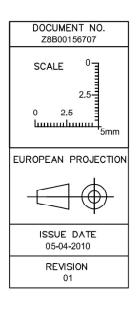


Figure 1 Outline PG-VSON-4, dimensions in mm/inches

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7 Appendix A

Table 11 Related Links

• IFX CoolMOS™ C7 Webpage: www.infineon.com

• IFX CoolMOS[™] C7 application note: <u>www.infineon.com</u>

• IFX CoolMOS™ C7 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

650V CoolMOS™ C7 Power Transistor

IPL65R070C7



Revision History

IPL65R070C7

Revision: 2017-08-29, Rev. 2.1

Previous Revision

Revision	Date	ate Subjects (major changes since last revision)				
2.0	2013-11-06	Release of final version				
2.1	2017-08-29	Updated MSL; style updated				

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